FAIRCHILD

SEMICONDUCTOR®

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ISL9V2540S3ST EcoSPARK® N-Channel Ignition IGBT 250mJ, 400V

Features

- SCIS Energy = 250mJ at T_J = 25°C
- Logic Level Gate Drive
- Qualified to AEC Q101
- RoHS Compliant

Applications

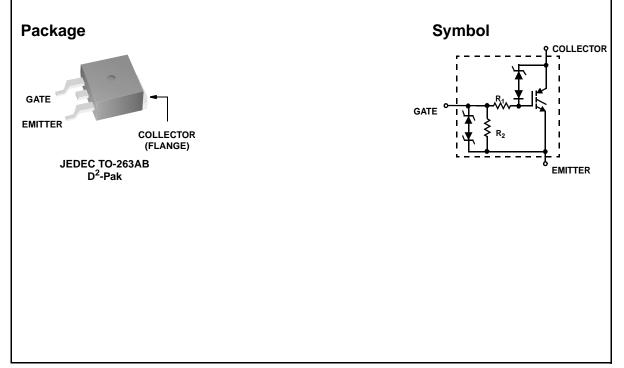
- Automotive Ignition Coil Driver Circuits
- Coil On Plug Applications

General Description

The ISL9V2540S3ST is a next generation ignition IGBT that offers outstanding SCIS capability in the industry standard D²-Pak (TO-263) plastic package. This device is intended for use in automotive ignition circuits, specifically as a coil driver. Internal diodes provide voltage clamping without the need for external components.

EcoSPARK® devices can be custom made to specific clamp voltages. Contact your nearest Fairchild sales office for more information.





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Symbol	Parameter	Ratings	Units
BV _{CFR}	Collector to Emitter Breakdown Voltage (I _C = 1 mA)	430	V
BV _{FCS}	Emitter to Collector Voltage - Reverse Battery Condition (I _C = 10 mA)	24	V
E _{SCIS25}	At Starting $T_J = 25^{\circ}$ C, $I_{SCIS} = 12.9$ A, L = 3.0mHy	250	mJ
ESCIS150	At Starting T _J = 150°C, I _{SCIS} = 10A, L = 3.0mHy	150	mJ
I _{C25}	Collector Current Continuous, At T _C = 25°C, See Fig 9	15.5	А
I _{C110}	Collector Current Continuous, At T _C = 110°C, See Fig 9	15.3	Α
V _{GEM}	Gate to Emitter Voltage Continuous	±10	V
PD	Power Dissipation Total $T_{C} = 25^{\circ}C$	166.7	W
	Power Dissipation Derating $T_{C} > 25^{\circ}C$	1.11	W/℃
TJ	Operating Junction Temperature Range	-40 to 175	C
T _{STG}	Storage Junction Temperature Range	-40 to 175	C
Τ _Ι	Max Lead Temp for Soldering (Leads at 1.6mm from Case for 10s)	300	C
Tpkg	Max Lead Temp for Soldering (Package Body for 10s)	260	C
ESD	Electrostatic Discharge Voltage at 100pF, 1500 Ω (HBM)	4	kV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
V2540S	ISL9V2540S3ST	TO-263AB	330mm	24mm	800 units

Electrical Characteristics $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Con	ditions	Min	Тур	Мах	Units
ff State	Characteristics						_
BV _{CER}	Collector to Emitter Breakdown Voltage	I _C = 2mA, V _{GE} = R _G = 1KΩ, See T _{.1} = -40 to 150°	e Fig. 15	370	400	430	V
BV _{CES}	Collector to Emitter Breakdown Voltage	$I_{C} = 10$ mA, $V_{GE} = 0$, $R_{G} = 0$, See Fig. 15 $T_{1} = -40$ to 150°C		390	420	450	V
BV _{ECS}	Emitter to Collector Breakdown Voltage	$I_{C} = -75$ mA, $V_{GE} = 0$ V, $T_{C} = 25$ °C		30	-	-	V
BV _{GES}	Gate to Emitter Breakdown Voltage	$I_{GES} = \pm 2mA$		±12	±14	-	V
I _{CER}	Collector to Emitter Leakage Current	V _{CER} = 250V,	T _C = 25°C	-	-	25	μA
		R _G = 1KΩ, See Fig. 11	T _C = 150°C	-	-	1	mA
I _{ECS}	Emitter to Collector Leakage Current	V _{EC} = 24V, See	T _C = 25°C	-	-	1	mA
		Fig. 11	T _C = 150°C	-	-	40	mA
R ₁	Series Gate Resistance			-	70	-	Ω
R_2	Gate to Emitter Resistance			10K	-	26K	Ω
n State	Characteristics						
$V_{CE(SAT)}$	Collector to Emitter Saturation Voltage	$I_{\rm C} = 6A,$	T _C = 25°C,	-	1.37	1.8	V

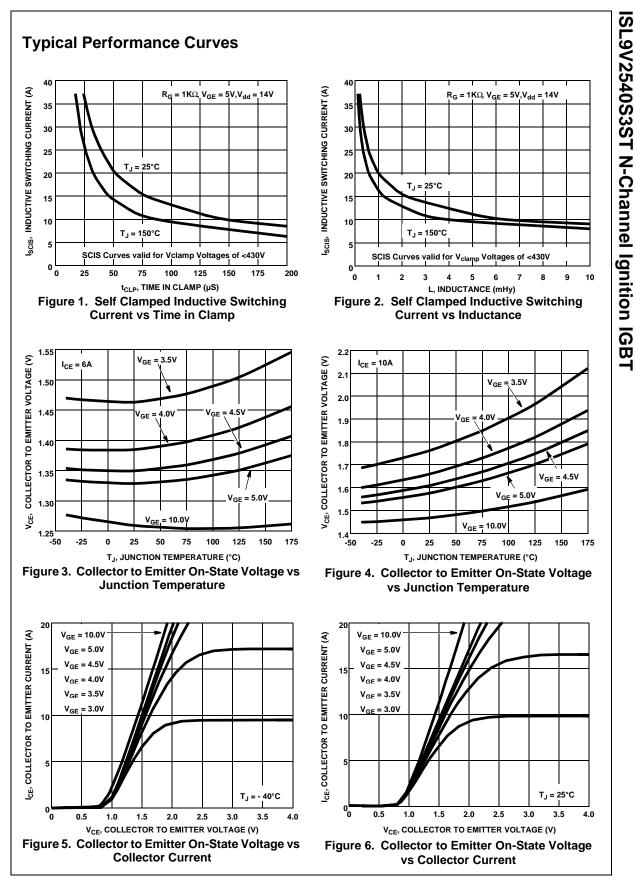
V _{CE(SAT)}	Collector to Emitter Saturation Voltage	I _C = 6A, V _{GF} = 4V	T _C = 25°C, See Fig. 3	-	1.37	1.8	V
V _{CE(SAT)}	Collector to Emitter Saturation Voltage	I _C = 10A, V _{GE} = 4.5V	T _C = 150℃ See Fig. 4	-	1.77	2.2	V



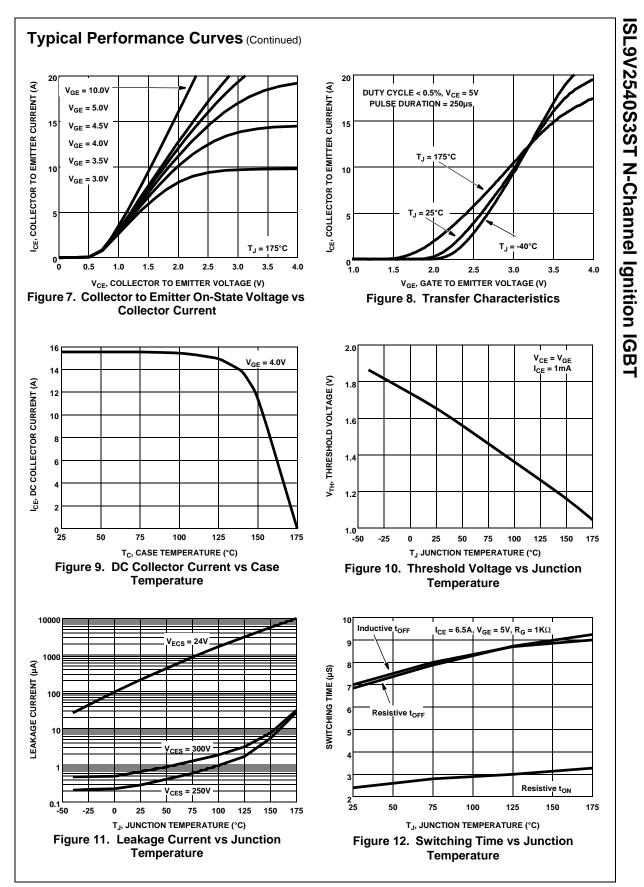
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Q _{G(ON)}	Gate Charge	I _C = 10A, V _{CE} V _{GE} = 5V, See		-	15.1	-	nC
V _{GE(TH)}	Gate to Emitter Threshold Voltage	$I_{\rm C} = 1.0 {\rm mA},$	$T_{\rm C} = 25^{\circ}{\rm C}$	1.3	-	2.2	V
()		V _{CE} = V _{GE,} See Fig. 10	T _C = 150°C	0.75	-	1.8	V
V_{GEP}	Gate to Emitter Plateau Voltage	I _C = 10A, V _{CF} = 12V		-	3.1	-	V
vitching	g Characteristics						
t _{d(ON)R}	Current Turn-On Delay Time-Resistive	V _{CE} = 14V, R _L		-	0.61	-	μs
t _{riseR}	Current Rise Time-Resistive	V _{GE} = 5V, R _G T _{.1} = 25℃	= 1ΚΩ	-	2.17	-	μs
t _{d(OFF)}	Current Turn-Off Delay Time-Inductive	V _{CE} = 300V, L		-	3.64	-	μs
t _{fL}	Current Fall Time-Inductive	V _{GE} = 5V, R _G T _{.1} = 25°C, Se	= 1KΩ e Fig. 12	-	2.36	-	μs
SCIS	Self Clamped Inductive Switching	T _J = 25°C, L = R _G = 1KΩ, V ₀ Fig. 1 & 2		-	-	250	mJ
ermal (Characteristics	<u>1. ig. i di 2</u>			•		1
R _{AJC}	Thermal Resistance Junction-Case	TO-263		-	_	0.9	°C/W
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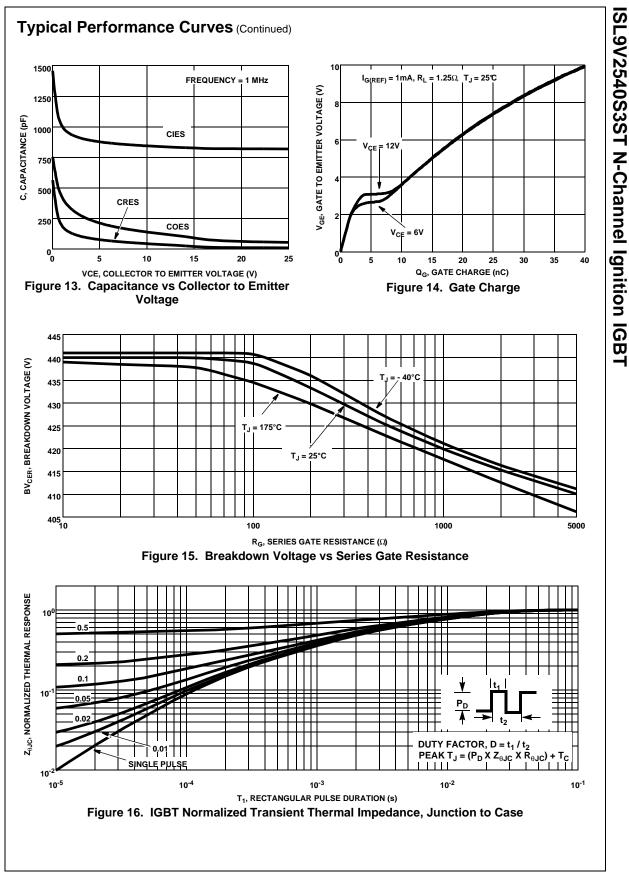
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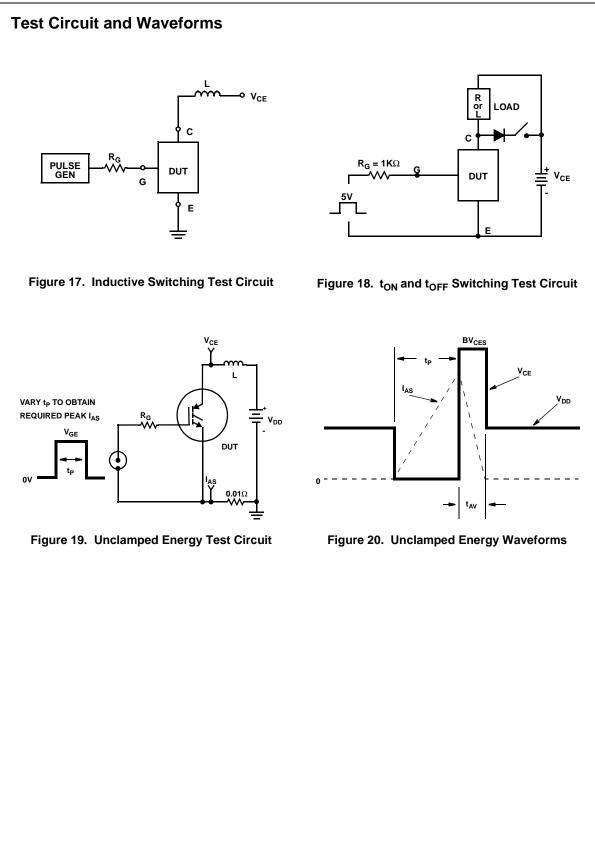
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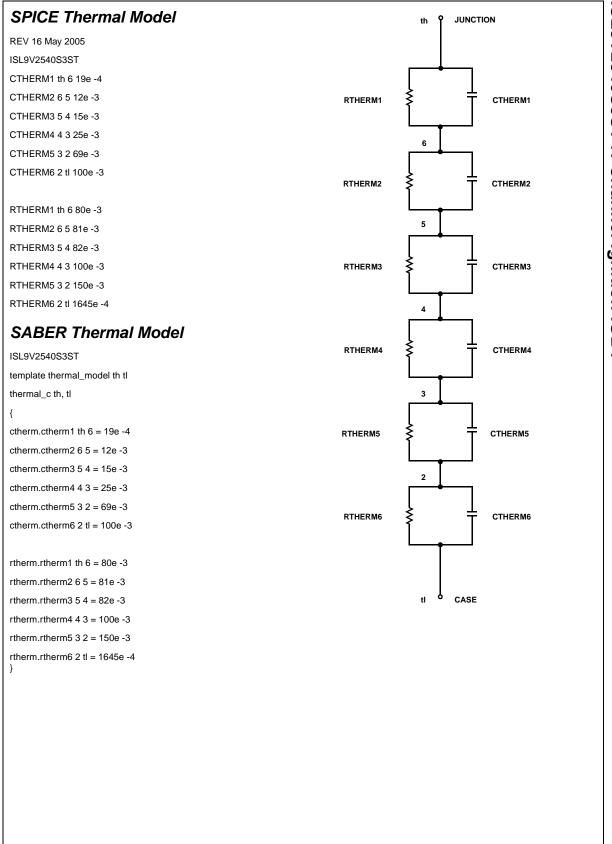


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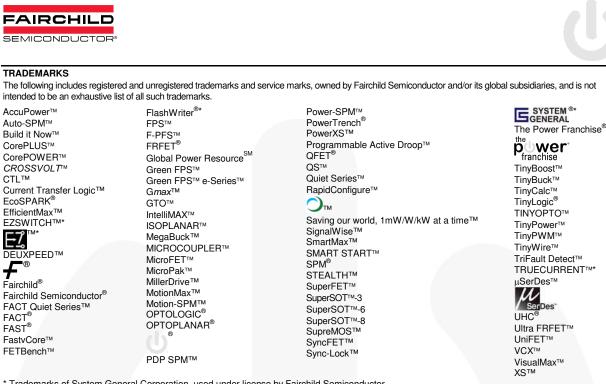


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